

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KAI-LUN WANG	07/18/2011
HOU-TE LIN	07/18/2011
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	ADVANCED OPTOELECTRONIC TECHNOLOGY, INC.
<b>Street Address:</b>	No. 13, Gongye 5th RD., Hsinchu Industrial Park, Hukou Shiang
<b>City:</b>	Hsinchu Hsien 303
<b>State/Country:</b>	TAIWAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	13186483
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(909)978-6366
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<b>ATTORNEY DOCKET NUMBER:</b>	US37562
<b>NAME OF SUBMITTER:</b>	Raymond J. Chew
<b>Total Attachments: 2</b> source=US37562110718ASM#page1.tif source=US37562110718ASM#page2.tif	

CH \$40.00 13186483

**ASSIGNMENT**

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- 1. KAI-LUN WANG , residing at Hukou, Hsinchu, Taiwan
- 2. HOU-TE LIN , residing at Hukou, Hsinchu, Taiwan
- 3. \_\_\_\_\_ , residing at \_\_\_\_\_
- 4. \_\_\_\_\_ , residing at \_\_\_\_\_
- 5. \_\_\_\_\_ , residing at \_\_\_\_\_
- 6. \_\_\_\_\_ , residing at \_\_\_\_\_
- 7. \_\_\_\_\_ , residing at \_\_\_\_\_
- 8. \_\_\_\_\_ , residing at \_\_\_\_\_

hereby sell(s), assign(s) and transfer(s) unto: ADVANCED OPTOELECTRONIC TECHNOLOGY, INC. having a principal place of business at No. 13, Gongye 5th Rd., Hsinchu Industrial Park, Hukou Shiang, Hsinchu Hsien 303, Taiwan, R.O.C. hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as LIGHT EMITTING DIODE PACKAGE for which the undersigned

[ ] previously executed --- Ser. No. \_\_\_\_\_ and filing date of \_\_\_\_\_  
[ x ] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>KAI - LUN WANG</u> KAI-LUN WANG	<u>July 18, 2011</u> Date
2.	<u>HOU-TE LIN</u> HOU-TE LIN	<u>July 18, 2011</u> Date
3.	_____	_____ Date
4.	_____	_____ Date
5.	_____	_____ Date
6.	_____	_____ Date
7.	_____	_____ Date
8.	_____	_____ Date
9.	_____	_____ Date